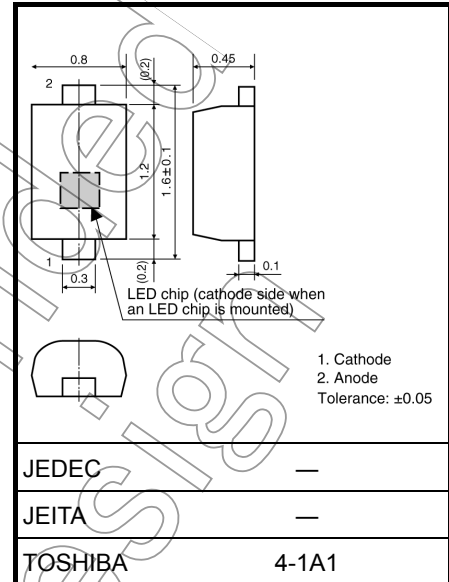


TLRH1032(T14,F), TLRMH1032(T14,F), TLSH1032(T14,F), TLOH1032(T14,F), TLYH1032(T14,F), TLGH1032(T14,F), TLFGH1032(T14,F)

Unit: mm

Panel Circuit Indicators

- Surface-mount devices
- 1.6 (L) mm × 0.8 (W) mm × 0.45 (H) mm (including lead length)
- InGaAlP LEDs
- High luminous intensity and low power consumption
- Colors: red, orange, yellow, green, pure green
- Applications: backlighting for LCDs and switches for automotive applications.
- Standard embossed tape packing: T14 (4000 / reel)
4-mm pitch



Weight: 0.001 g (typ.)

Color and Material

Part Number	Color	Material
TLRH1032	Red	InGaAlP
TLRMH1032	Red	
TLSH1032	Red	
TLOH1032	Orange	
TLYH1032	Yellow	
TLGH1032	Green	
TLFGH1032	Fresh Green	

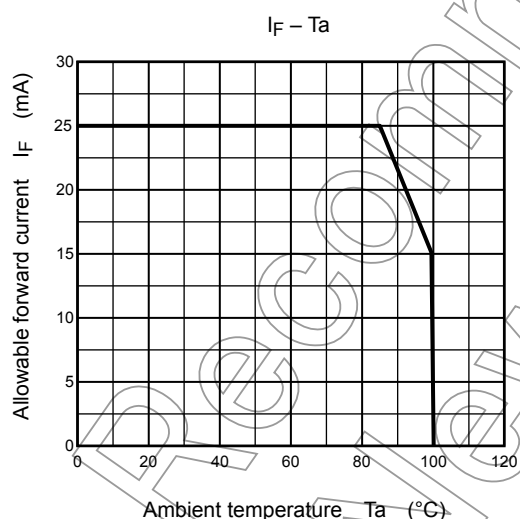
Absolute Maximum Ratings (Ta = 25°C)

Part Number	Forward Current I _F (mA) Please see Note 1	Reverse Voltage V _R (V)	Power Dissipation P _D (mW)	Operating Temperature T _{opr} (°C)	Storage Temperature T _{stg} (°C)
TLRH1032	25	4	60	-40 to 100	-40 to 100
TLRMH1032					
TLSH1032					
TLOH1032					
TLYH1032			62.5		
TLGH1032					
TLFGH1032					

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Forward current derating



Electrical Characteristics (Ta = 25°C)

Part Number	Forward Voltage V _F			I _F	Reverse Current I _R	
	Min	Typ.	Max		Max	V _R
TLRH1032	1.7	2.0	2.4	20	10	4
TLRMH1032	1.7	2.0	2.4			
TLSH1032	1.7	2.0	2.4			
TLOH1032	1.7	2.0	2.4			
TLYH1032	1.7	2.0	2.4			
TLGH1032	1.8	2.1	2.5			
TLFGH1032	1.9	2.2	2.5			
Unit	V			mA	μA	V

Optical Characteristics-1 (Ta = 25°C)

Part Number	Luminous Intensity I _v				Available I _v rank Please see Note 2
	Min	Typ.	Max	I _F	
TLRH1032	25	56	125	20	NA / PA / QA
TLRMH1032	40	85	200		PA / QA / RA
TLSH1032	63	160	320		QA / RA / SA
TLOH1032	100	200	500		RA / SA / TA
TLYH1032	40	100	200		PA / QA / RA
TLGH1032	25	60	125		NA / PA / QA
TLFGH1032	10	25	50		LA / MA / NA
Unit	mcd	mcd	mcd	mA	—

Note 2: The specification on the above table is used for I_v classification of LEDs in Toshiba facility.
Each reel includes the same rank LEDs. Let the delivery ratio of each rank be unquestioned.

Rank	Luminous Intensity I _v	
	Min	Max
LA	10	20
MA	16	32
NA	25	50
PA	40	80
QA	63	125
RA	100	200
SA	160	320
TA	250	500
Unit	mcd	mcd

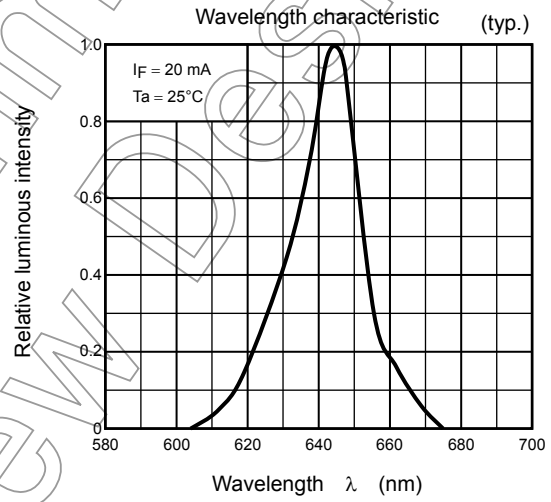
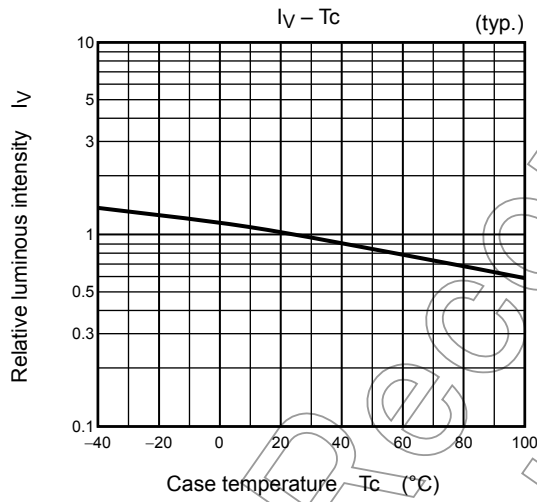
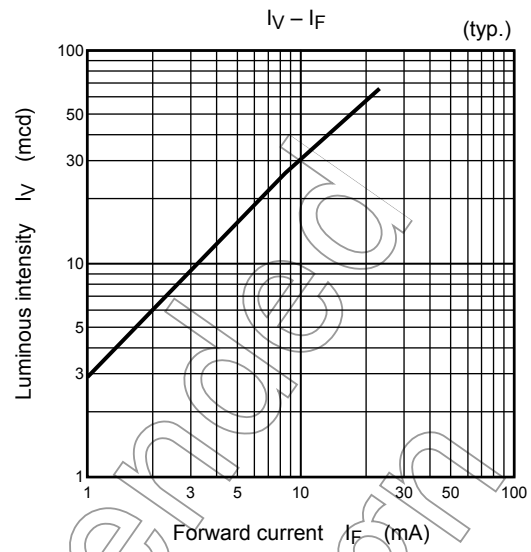
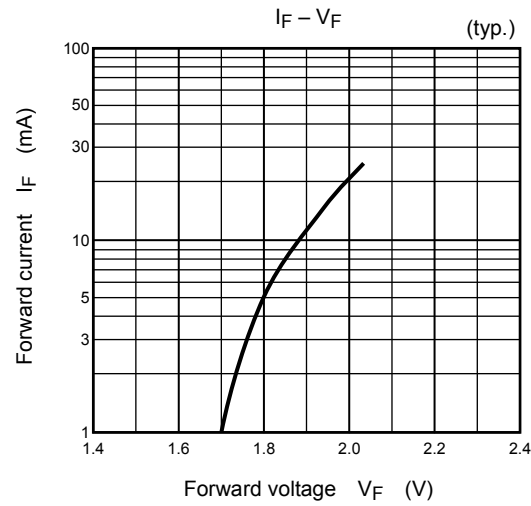
Optical Characteristics-2 (Ta = 25°C)

Part Number	Peak Emission Wavelength λ_p			Emission Spectrum				I _F
	Min	Typ.	Max	$\Delta\lambda$	Dominant Wavelength λ_d			
				Typ.	Min	Typ.	Max	
TLRH1032	—	644	—	17	624	630	638	20
TLRMH1032	—	636	—	17	620	626	634	
TLSH1032	—	623	—	17	607	613	621	
TLOH1032	—	612	—	17	599	605	613	
TLYH1032	—	590	—	13	581	587	595	
TLGH1032	—	574	—	13	565	571	576	
TLFGH1032	—	568	—	11	560	565	571	
Unit	nm			nm	nm			mA

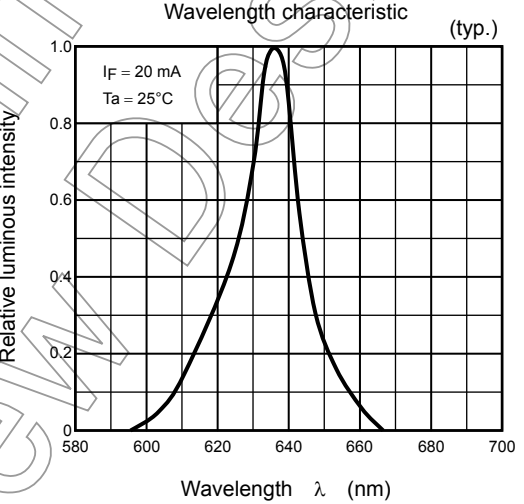
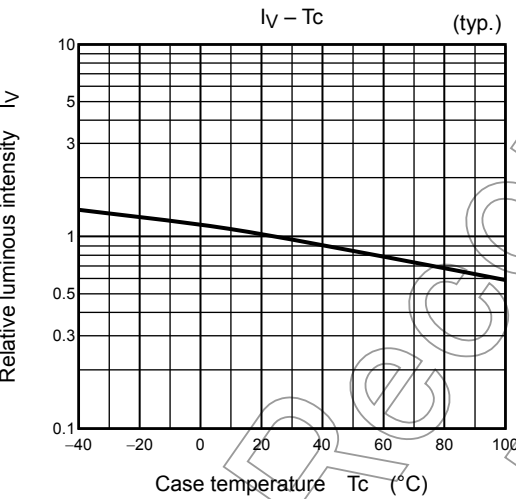
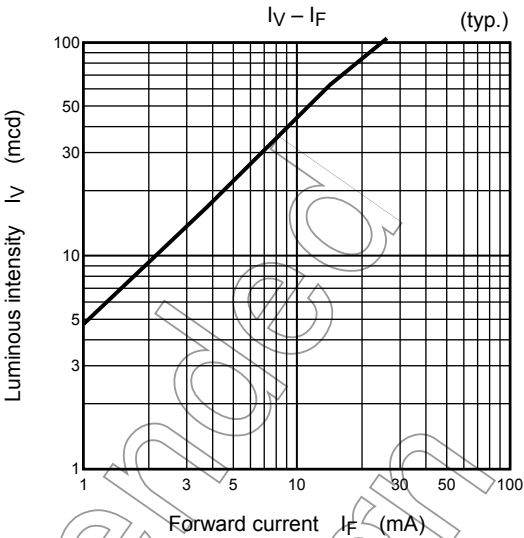
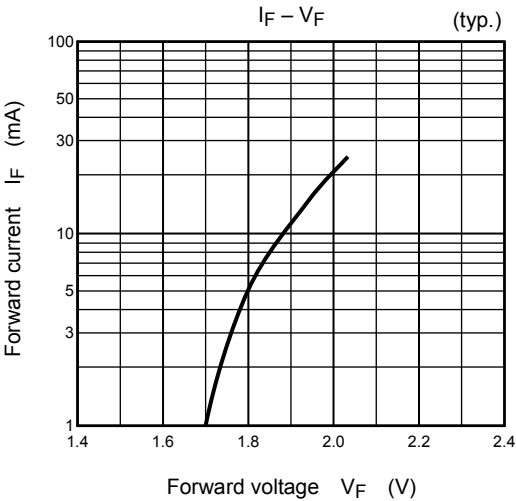
The cautions

- This visible LED lamp also emits some IR light.
If a photodetector is located near the LED lamp, please ensure that it will not be affected by the IR light.
- This product is designed as a general display light source usage, and it has applied the measurement standard that matched with the sensitivity of human's eyes. Therefore, it is not intended for usage of functional application (ex. Light source for sensor, optical communication and etc) except general display light source.

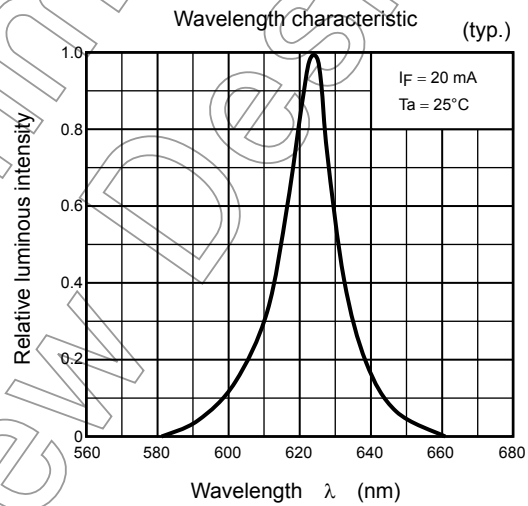
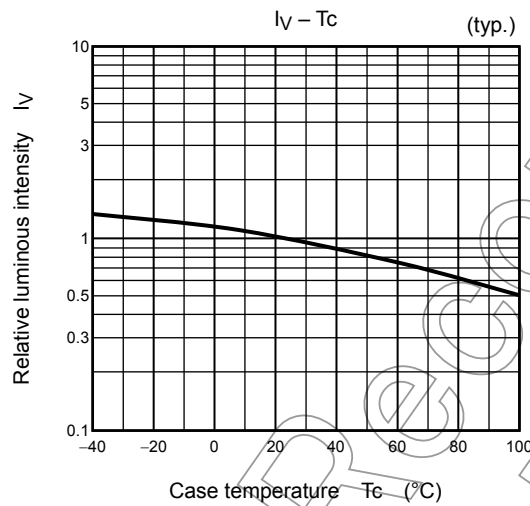
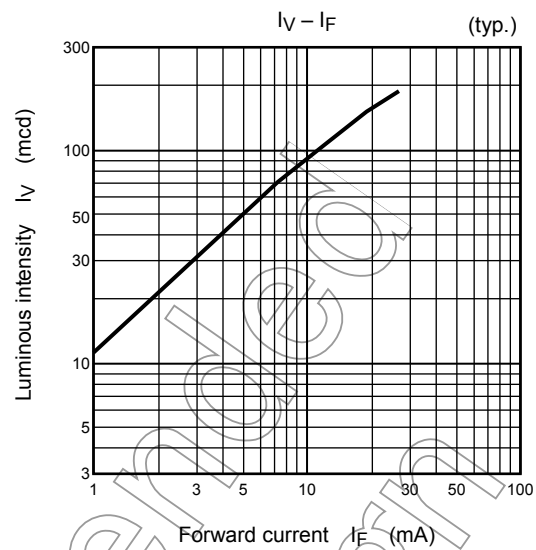
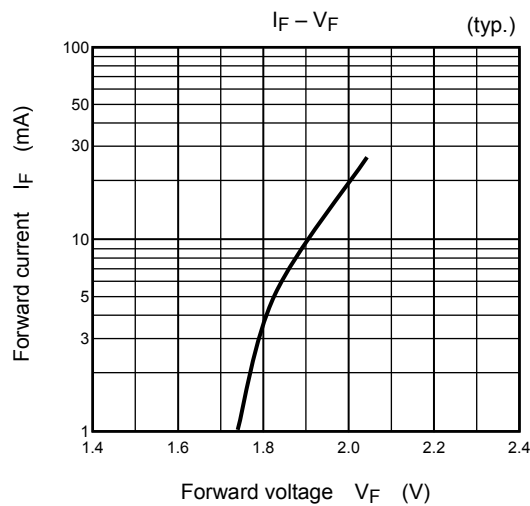
TLRH1032



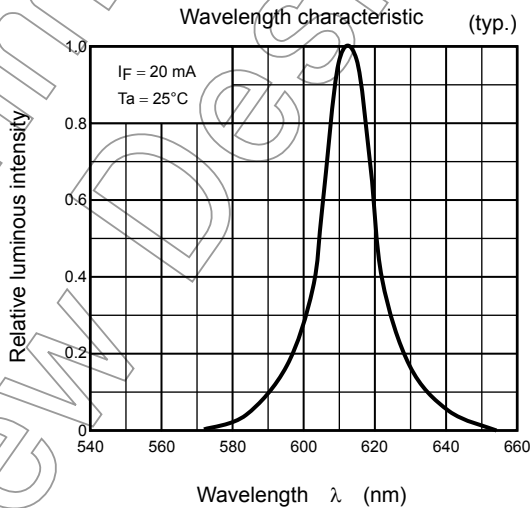
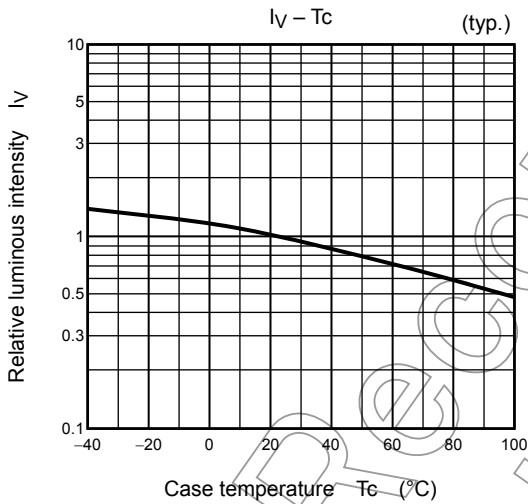
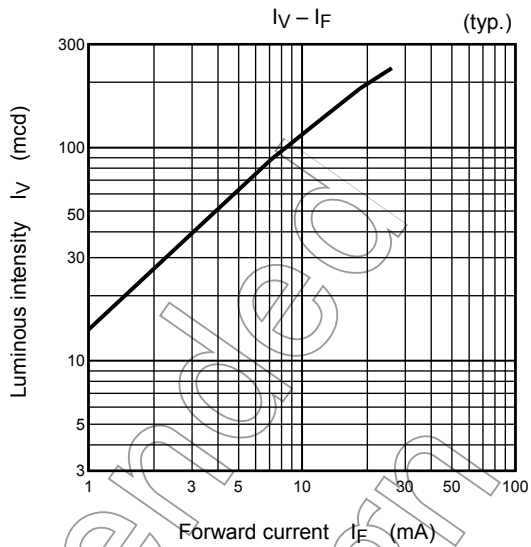
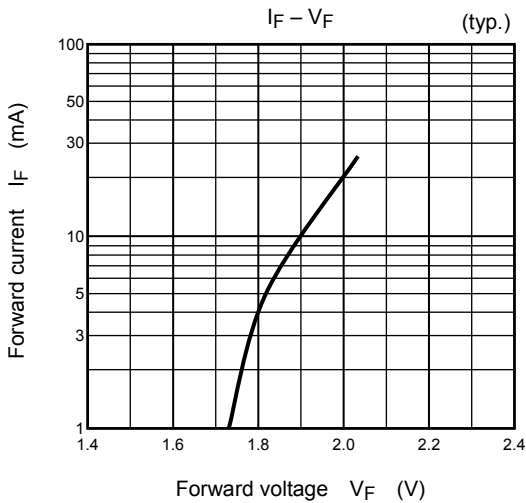
TLRMH1032



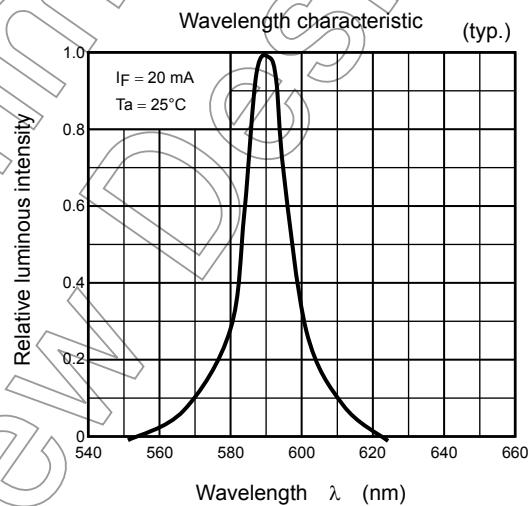
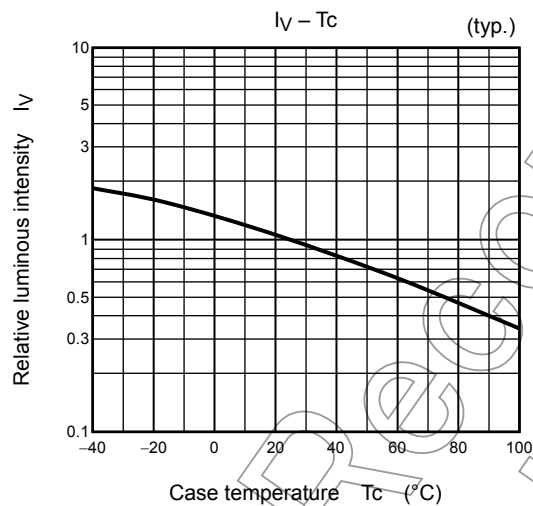
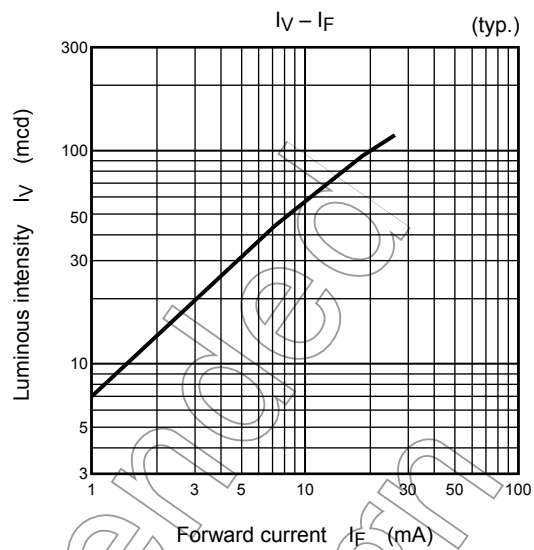
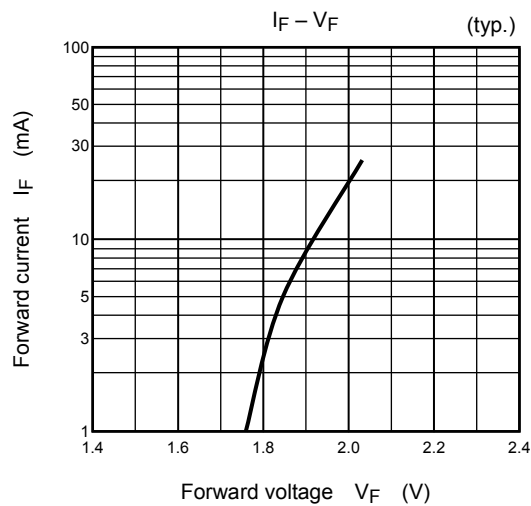
TLSH1032



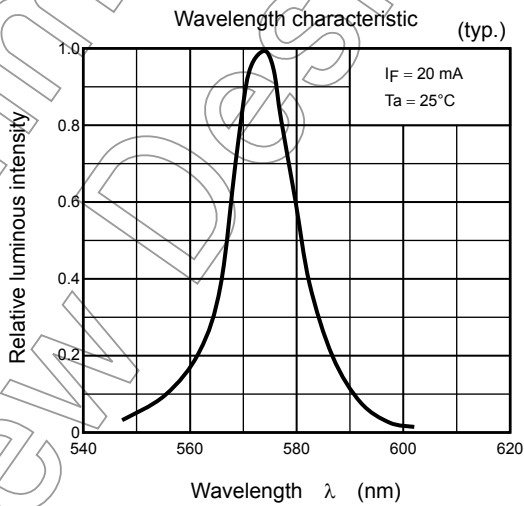
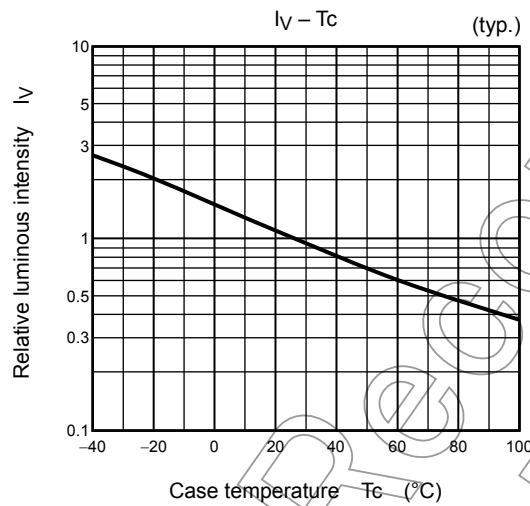
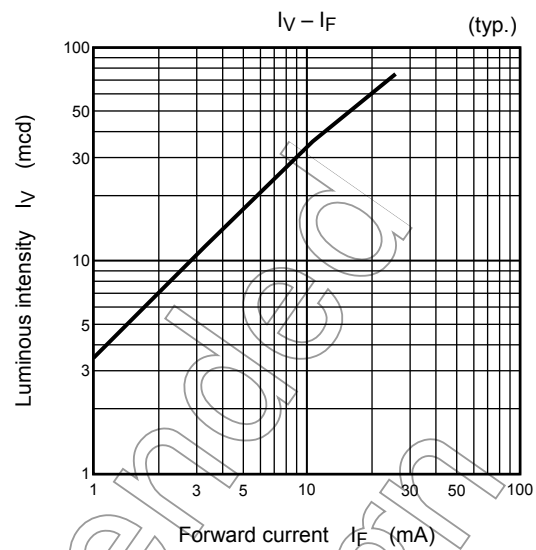
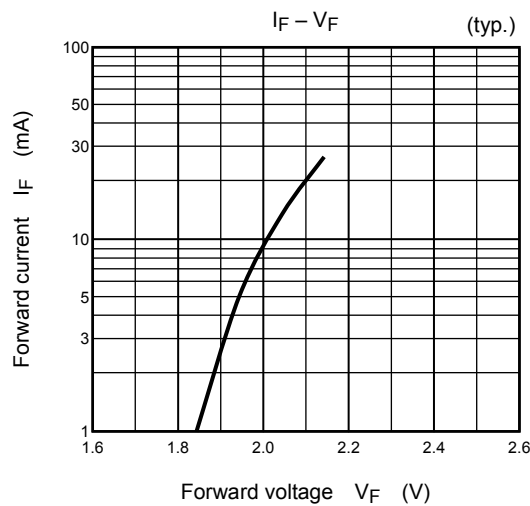
TLOH1032



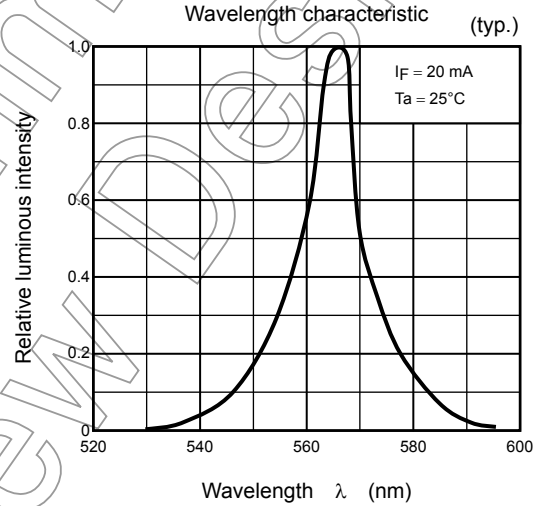
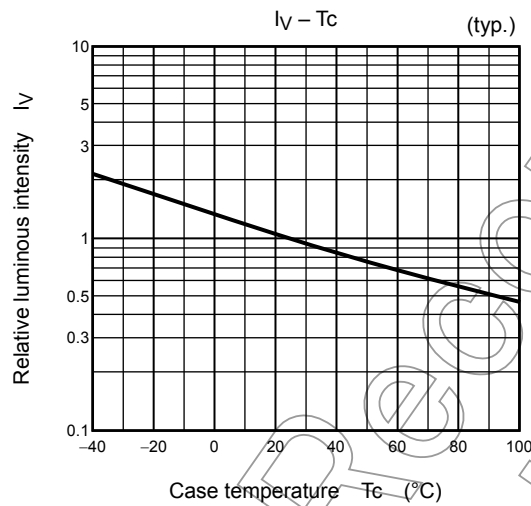
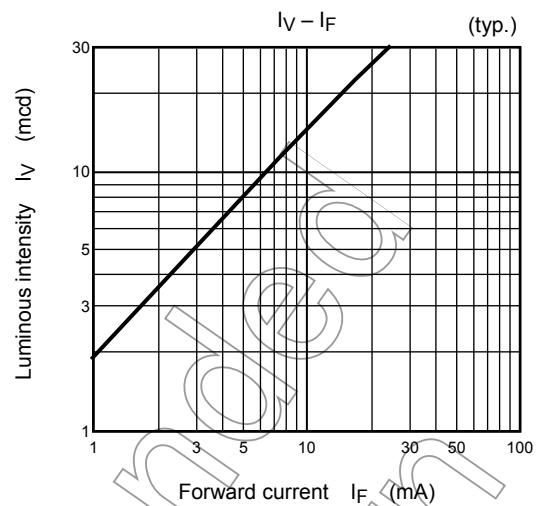
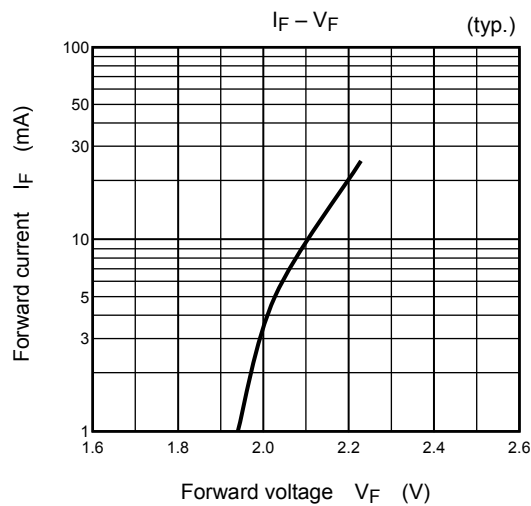
TLYH1032



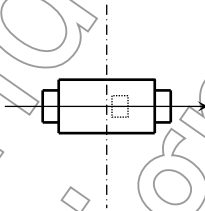
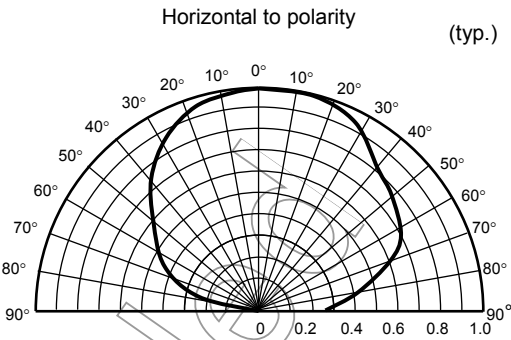
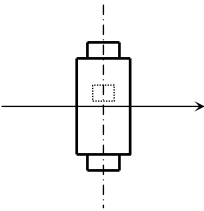
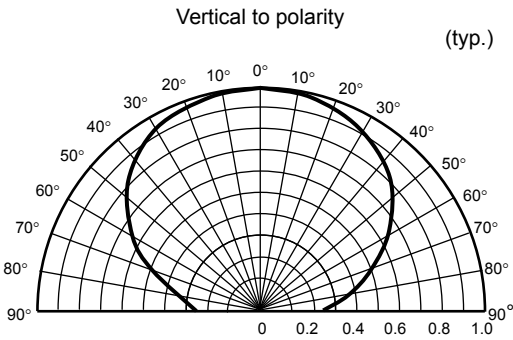
TLGH1032



TLFGH1032



Radiation Pattern



Not Recommended for New Design

Packaging

These LED devices are packed in an aluminum envelope with a silica gel and a moisture indicator to avoid moisture absorption. The optical characteristics of the devices may be affected by exposure to moisture in the air before soldering and they should therefore be stored under the following conditions:

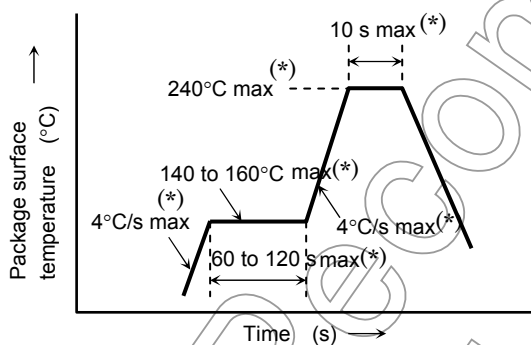
1. This moisture proof bag may be stored unopened within 12 months at the following conditions.
Temperature: 5°C to 30°C
Humidity: 90% (max)
2. After opening the moisture proof bag, the devices should be assembled within 168 hours in an environment of 5°C to 30°C/70% RH or below.
3. If upon opening, the moisture indicator card shows humidity 30% or above (Color of indication changes to pink) or the expiration date has passed, the devices should be baked in taping with reel.
After baking, use the baked devices within 72 hours, but perform baking only once.
Baking conditions: 60±5°C, for 12 to 24 hours.
Expiration date: 12 months from sealing date, which is imprinted on the same side as this label affixed.
4. Repeated baking can cause the peeling strength of the taping to change, then leads to trouble in mounting.
Furthermore, prevent the devices from being destructed against static electricity for baking of it.
5. If the packing material of laminate would be broken, the air tightness would deteriorate. Therefore, do not throw or drop the packed devices.

Mounting Method

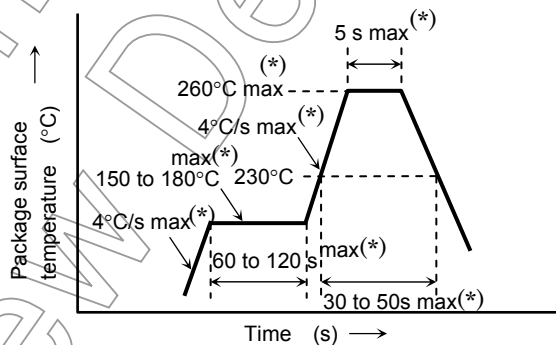
Soldering

- Reflow soldering (example)

Temperature profile for Pb soldering (example)

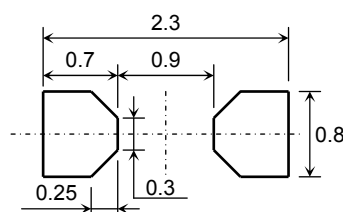


Temperature profile for Pb-free soldering (example)



- The products are evaluated using above reflow soldering conditions. No additional test is performed exceed the condition (i.e. the condition more than (*)MAX values) as a evaluation. Please perform reflow soldering under the above conditions.
- Please perform the first reflow soldering with reference to the above temperature profile and within 168 h of opening the package.
- Second reflow soldering
In case of second reflow soldering should be performed within 168 h of the first reflow under the above conditions.
Storage conditions before the second reflow soldering: 30°C, 70% RH (max)
- Make any necessary soldering corrections manually.
(only once at each soldering point)
Soldering iron: 25 W
Temperature: 300°C or less
Time: within 3 s
- If the products need to be performed by other soldering method (ex. wave soldering), please contact Toshiba sales representative.

Recommended soldering pattern



Unit: mm

Cleaning

When cleaning is required after soldering, Toshiba recommends the following cleaning solvents.
It is confirmed that these solvents have no effect on semiconductor devices in our dipping test (under the recommended conditions). In selecting the one for your actual usage, please perform sufficient review on washing condition, using condition and etc.

ASAHI CLEAN AK-225AES:	(made by ASAHI GLASS)
KAO CLEAN THROUGH 750H:	(made by KAO)
PINE ALPHA ST-100S:	(made by ARAKAWA CHEMICAL)

Precaution when mounting

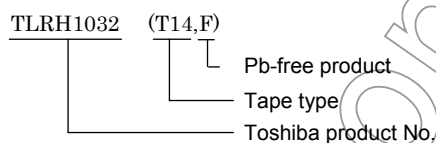
Do not apply force to the plastic part of the LED under high-temperature conditions.
To avoid damaging the LED plastic, do not apply friction using a hard material.
When installing the PCB in a product, ensure that the device does not come into contact with other components.

Tape Specifications

1. Product number format

The type of package used for shipment is denoted by a symbol suffix after the product number. The method of classification is as below. (However, this method does not apply to products whose electrical/optical characteristics differ from standard Toshiba specifications)

- (1) Tape Type: T14 (4-mm pitch)
- (2) Example



2. Handling precautions

Tape material protected against static electricity. However, static electricity may occur depending on quantity of charged static electricity and a device may attach to a tape, or a device may be unstable when peeling a tape cover.

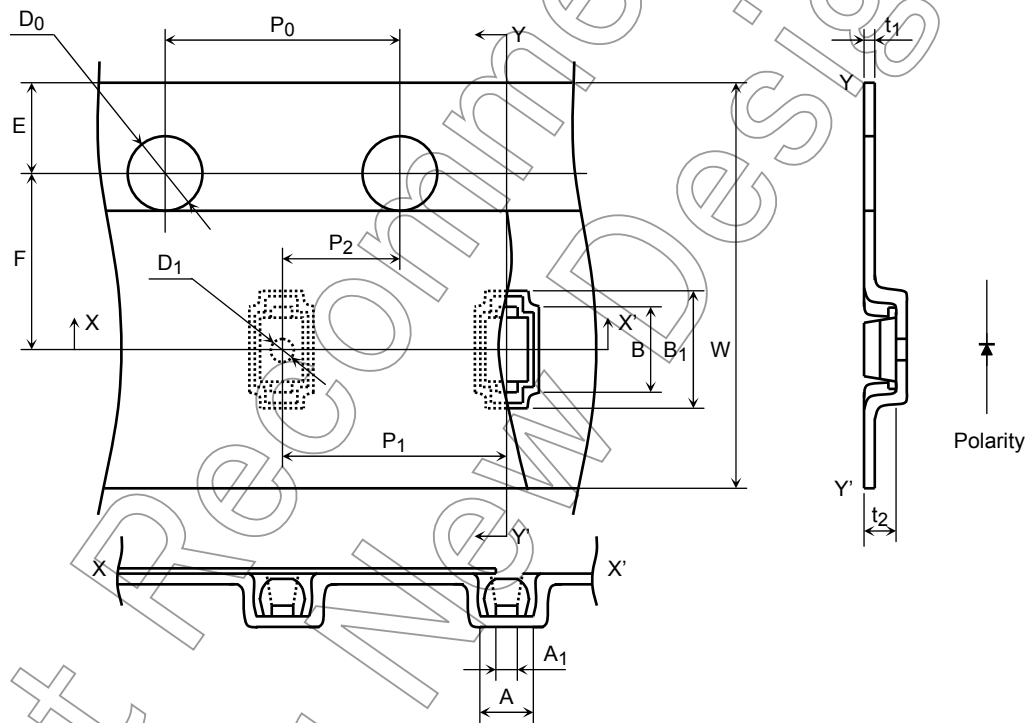
- (a) Since tape materials may accumulate an electrostatic charge, use an ionizer to neutralize the ambient air.
- (b) For transport and temporary storage of devices, use containers (boxes and bags) and jigs that are made of anti-static materials or of materials which dissipate electrostatic charge.

3. Tape dimensions

Unit: mm

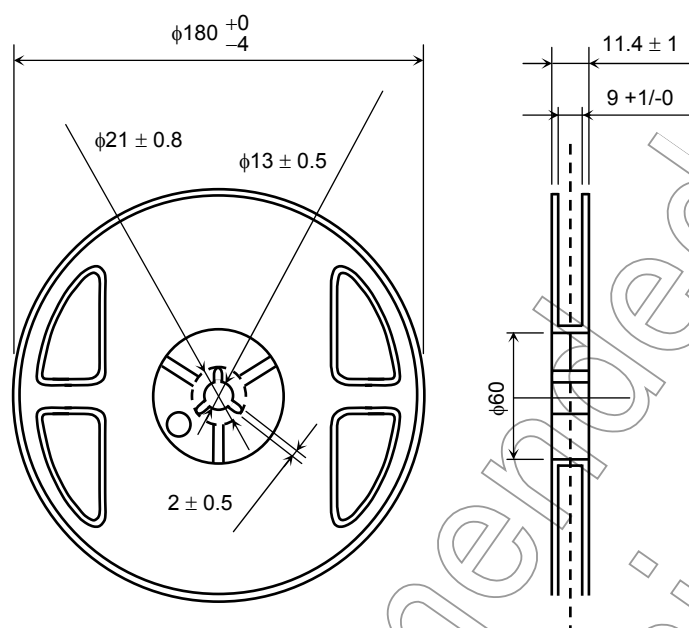
Item		Symbol	Value	Tolerance
Carrier tape	Width	W	8.0	±0.2
	Thickness	t ₁	0.2	±0.05
Feed hole	Diameter	D ₀	1.50	+0.1/-0
	Pitch	P ₀	4.0	±0.1
	Position	E	1.75	±0.1
Distance from center line	Vertical Direction (1)	P ₁	4.0	±0.1
	Vertical Direction (2)	P ₂	2.0	±0.1
	Horizontal Direction	F	3.5	±0.1

Item		Symbol	Value	Tolerance
Cavity	Length	B ₁	1.85	±0.05
		B	1.3	±0.05
	Width	A	0.9	±0.05
		A ₁	0.4	±0.05
	Depth	t ₂	0.52	±0.05
	Diameter of mark hole	D ₁	0.5	±0.05

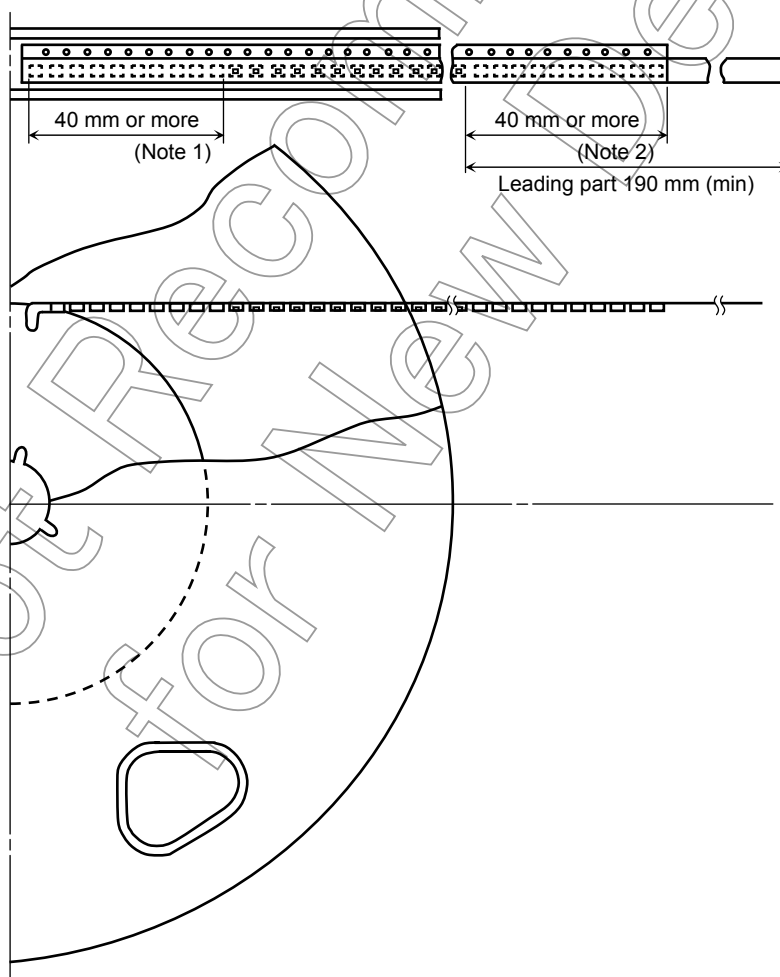


4. Reel dimensions

Unit: mm



5. Leader and trailer section of tape



Note 1: Empty trailer section

Note 2: Empty leader section

6. Packing display

(1) Packing quantity

Reel	4,000 pcs
Carton	20,000 pcs

(2) Package form: Each reel is sealed in an aluminum pack with silica gel.

7. Label format

(1) Example: TLRH1032 (T14,F)

P/N:

TYPE	TLRH1032		
ADDC	(T14,F)	Q'TY	4,000 pcs

Lot Number

Key code for TSB

(RANK SYMBOL)

32C

4000

Use under 5-30degC/70%RH within 168h

[[G]]/RoHS COMPATIBLE


Y380xxxxxxxxxxxxxxxxx


SEALD

DIFFUSED IN *****

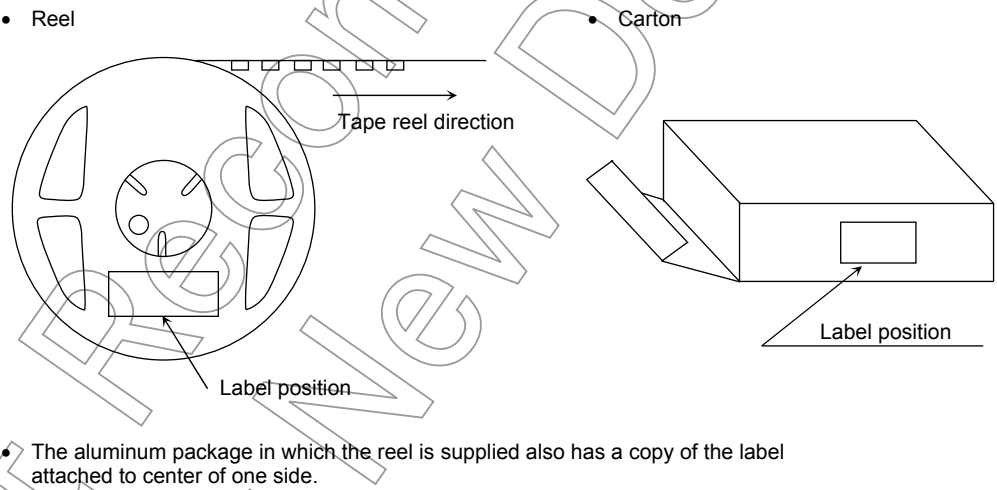
ASSEMBLED IN *****

TOSHIBA





(2) Label location



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- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
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- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. TOSHIBA assumes no liability for damages or losses occurring as a result of noncompliance with applicable laws and regulations.